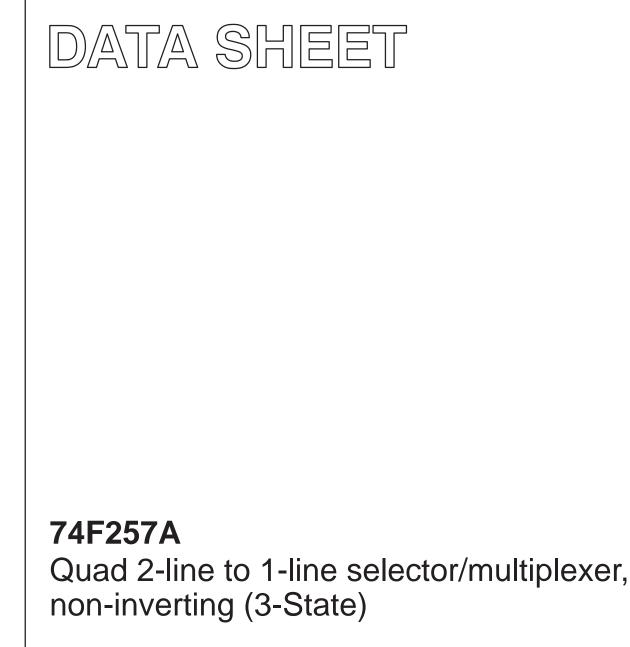
## INTEGRATED CIRCUITS



Product specification

1995 Mar 31

IC15 Data Handbook

**Philips Semiconductors** 





74F257A

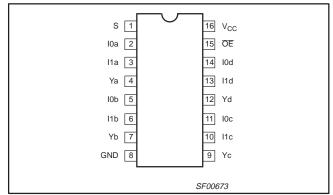
#### FEATURES

- Industrial range available (-40°C to +85°C)
- Multifunction capability
- Non-inverting data path
- 3-State outputs
- See 74F258A for inverting version

#### DESCRIPTION

The 74F257A has four identical 2-input multiplexers with 3-State outputs which select 4 bits of data from two sources uncer control of a common Select (S) input. The I0a inputs are selected when the common Select input is Low and the I1n inputs are selected when the common Select input is High. Data appears at the outputs in true non-inverted form from the selected inputs. The 74F257A is the logic implementation of a 4-pole, 2-position switch where the position of the switch is determined by the logic levels supplied to the common Slect input. Outputs are forced to a high impedance "off" state when the Output Enable ( $\overline{OE}$ ) is High. All but one device must be in high impedance state to avoid currents that would exceed the maximum rating if the outputs were tied together. Design of the Output Enable signals must ensure that there is no overlap when outputs of 3-state devices were tied together.

#### **PIN CONFIGURATION**



TYPE	TYPICAL PROPAGATION DELAY	TYPICAL SUPPLY CURRENT (TOTAL)
74F257A	4.3ns	12mA

### **ORDERING INFORMATION**

	ORDER	DRAWING	
DESCRIPTION	COMMERCIAL RANGE $V_{CC}$ = 5V ±10%, $T_{amb}$ = 0°C to +70°C	INDUSTRIAL RANGE $V_{CC}$ = 5V ±10%, $T_{amb}$ = -40°C to +85°C	NUMBER
16-pin plastic DIP	N74F257AN	I74F257AN	SOT38-4
16-pin plastic SO	N74F257AD	I74F257AD	SOT109-1

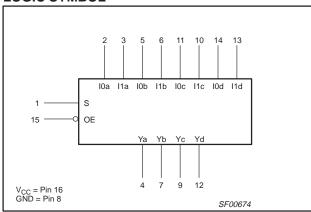
#### INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

PINS	DESCRIPTION	74F (U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
l0n, l1n	Data inputs	1.0/1.0	20µA/0.6mA
S	Common Select input	1.0/1.0	20µA/0.6mA
ŌĒ	Output Enable input (active Low)	1.0/1.0	20µA/0.6mA
Ya – Yd	Data outputs	150/33	3.0mA/20mA

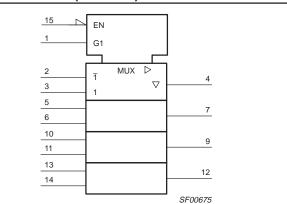
NOTE:

One (1.0) FAST unit load is defined as:  $20\mu$ A in the High state and 0.6mA in the Low state.

#### LOGIC SYMBOL

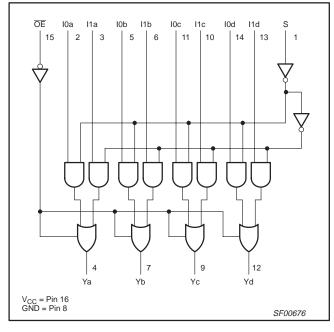


#### LOGIC SYMBOL (IEEE/IEC)



74F257A

#### LOGIC DIAGRAM



#### **FUNCTION TABLE**

	INP	OUTPUT		
OE	S	10	11	Y
н	Х	Х	Х	Z
L	н	Х	L	L
L	н	Х	Н	Н
L	L	L	Х	L
L	L	н	Х	Н

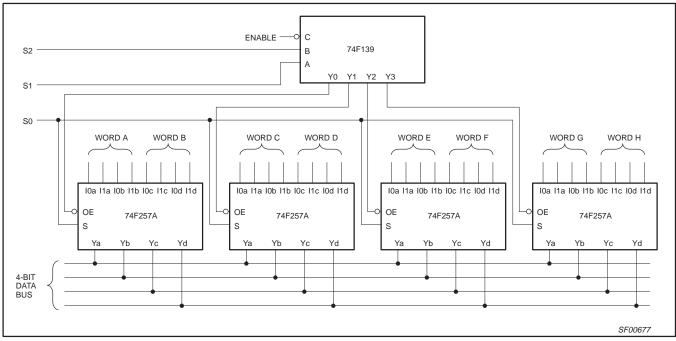
Н High voltage level =

Low voltage level =

Don't care =

L X Z High impedance "off" state =

#### **APPLICATION**



74F257A

#### **ABSOLUTE MAXIMUM RATINGS**

(Operation beyond the limits set forth in this table may impair the useful life of the device. Unless otherwise noted these limits are over the operating free-air temperature range.)

SYMBOL	PARAMETER		RATING	UNIT
V <sub>CC</sub>	Supply voltage		-0.5 to +7.0	V
V <sub>IN</sub>	Input voltage		-0.5 to +7.0	V
I <sub>IN</sub>	Input current		-30 to +5	mA
V <sub>OUT</sub>	Voltage applied to output in High output state		-0.5 to V <sub>CC</sub>	V
I <sub>OUT</sub>	Current applied to output in Low output state		48	mA
Ŧ		Commercial range	0 to +70	°C
T <sub>amb</sub> Operating free-air temperature range		Industrial range	-40 to +85	°C
T <sub>stg</sub>	Storage temperature range	-65 to +150	°C	

### **RECOMMENDED OPERATING CONDITIONS**

SYMPOL	SYMBOL PARAMETER			LIMITS		UNIT
STMBOL					MAX	UNIT
V <sub>CC</sub>	Supply voltage		4.5	5.0	5.5	V
V <sub>IH</sub>	High-level input voltage		2.0			V
VIL	Low-level input voltage			0.8	V	
I <sub>IK</sub>	Input clamp current				-18	mA
I <sub>OH</sub>	High-level output current				-3	mA
I <sub>OL</sub>	Low-level output current			24	mA	
T <sub>amb</sub>		Commercial range	0		+70	°C
	Operating free-air temperature range	Industrial range	-40		+85	°C

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#### DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

CYMDOL	DADAMETED				LIMITS			
SYMBOL PARAMETER			TEST CONDITIO	MIN	TYP <sup>2</sup>	MAX	UNIT	
M			$V_{CC} = MIN, V_{II} = MAX,$	±10%V <sub>CC</sub>	2.4			V
V <sub>OH</sub>	High-level output voltage			±5%V <sub>CC</sub>	2.7	3.3		V
			V <sub>CC</sub> = MIN, V <sub>IL</sub> = MAX,	±10%V <sub>CC</sub>		0.35	0.50	V
V <sub>OL</sub>	Low-level output voltage		$V_{IH} = MIN, I_{OL} = MAX$	±5%V <sub>CC</sub>		0.35	0.50	V
V <sub>IK</sub>	Input clamp voltage		$V_{CC} = MIN, I_I = I_{IK}$			-0.73	-1.2	V
l <sub>l</sub>	Input current at maximum input voltage		$V_{CC} = MAX, V_I = 7.0V$				100	μΑ
I <sub>IH</sub>	High-level input current		V <sub>CC</sub> = MAX, V <sub>I</sub> = 2.7V			20	μΑ	
IIL	Low-level input current		$V_{CC} = MAX, V_I = 0.5V$			-0.6	mA	
I <sub>OZH</sub>	Off state output current, High-level voltage applied		$V_{CC} = MAX, V_O = 2.7V$				50	μΑ
I <sub>OZL</sub>	Off state output current, Low-level voltage applied		$V_{CC} = MAX, V_O = 0.5V$				-50	μΑ
I <sub>OS</sub>	Short-circuit output current <sup>3</sup>		V <sub>CC</sub> = MAX		-60		-150	mA
	I <sub>ССН</sub>					9.0	15.0	mA
I <sub>CC</sub>	Supply current <sup>4</sup> (total)	I <sub>CCL</sub>	V <sub>CC</sub> = MAX			14.5	22.0	mA
I F		I <sub>CCZ</sub>	1		15.0	23.0	mA	

#### NOTES:

1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.

2. All typical values are at  $V_{CC} = 5V$ ,  $T_{amb} = 25^{\circ}C$ . 3. Not more than one output should be shorted at a time. For testing  $I_{OS}$ , the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a High output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, I<sub>OS</sub> tests should be performed last.

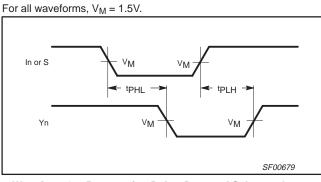
4. Measure I<sub>CC</sub> with all outputs open and inputs grounded.

### **AC ELECTRICAL CHARACTERISTICS**

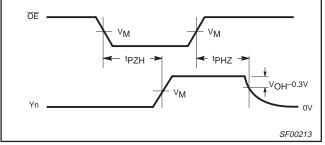
						LI	MITS			
SYMBOL PARAMETER		TEST CONDITION	$T_{amb} = +25^{\circ}C \\ V_{CC} = +5.0V \\ C_{L} = 50pF \\ R_{L} = 500\Omega$		$\begin{array}{l} \textbf{T}_{amb} = \textbf{0}^\circ \textbf{C} \text{ to } + 70^\circ \textbf{C} \\ \textbf{V}_{\textbf{CC}} = +5.0 \textbf{V} \pm 10\% \\ \textbf{C}_{\textbf{L}} = 50 \textbf{pF} \\ \textbf{R}_{\textbf{L}} = 500 \Omega \end{array}$		$\begin{array}{l} T_{amb}=-40^\circ C \ to \ +85^\circ C \\ V_{CC}=+5.0V \pm 10\% \\ C_L=50pF \\ R_L=500\Omega \end{array}$		UNIT	
			MIN	ТҮР	MAX	MIN	MAX	MIN	MAX	
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay In to Yn	Waveform 1	3.0 2.0	4.5 3.5	6.0 5.0	3.0 2.0	7.0 6.0	3.0 2.0	7.0 7.0	ns
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay S to Yn	Waveform 1	5.0 4.0	7.5 5.5	9.5 7.0	5.0 4.0	10.5 8.0	5.0 4.0	10.5 8.5	ns
t <sub>PZH</sub> t <sub>PZL</sub>	Output Enable time to High or Low level	Waveform 2 Waveform 3	4.5 4.5	6.5 6.0	7.5 7.5	4.5 4.5	8.5 8.5	4.5 4.5	8.5 8.5	ns
t <sub>PHZ</sub> t <sub>PLZ</sub>	Output Disable time from High or Low level	Waveform 2 Waveform 3	2.0 2.0	4.0 3.5	5.5 5.5	2.0 2.0	6.0 6.0	2.0 2.0	6.0 6.0	ns

## 74F257A

#### AC WAVEFORMS

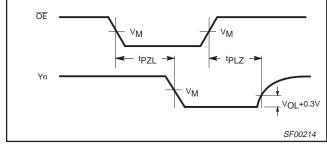


Waveform 1. Propagation Delay, Data and Select to Output

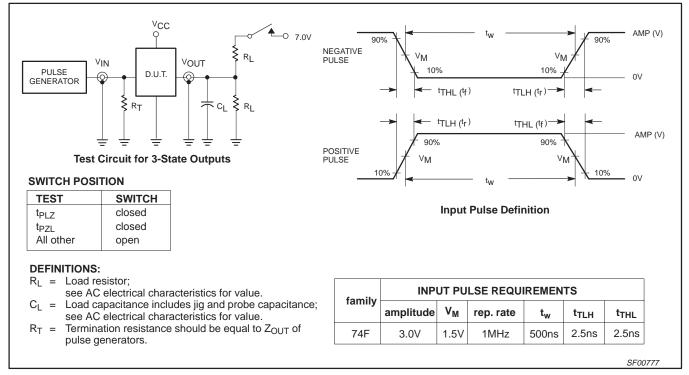


Waveform 2. 3-State Output Enable Time to High Level and Output Disable Time from High Level

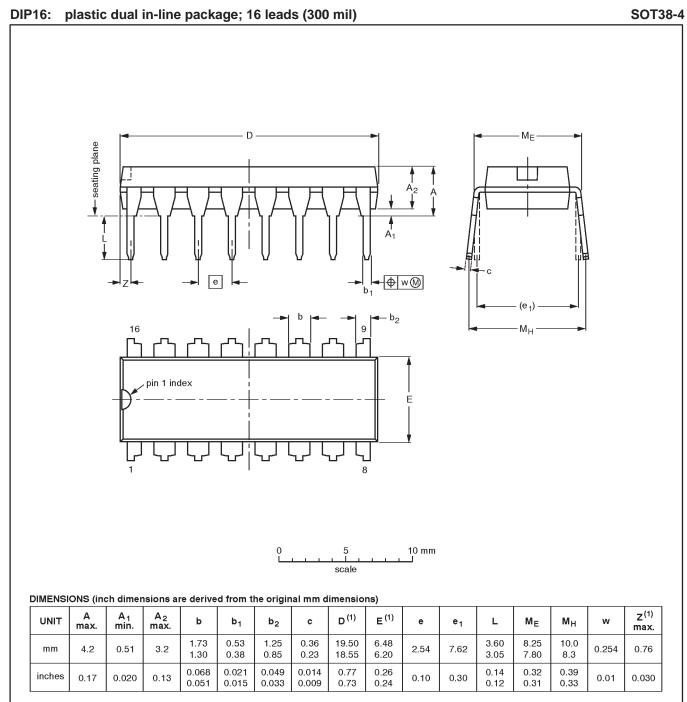
#### **TEST CIRCUIT AND WAVEFORMS**



Waveform 3. 3-State Output Enable Time to Low Level and Output Disable Time from Low Level



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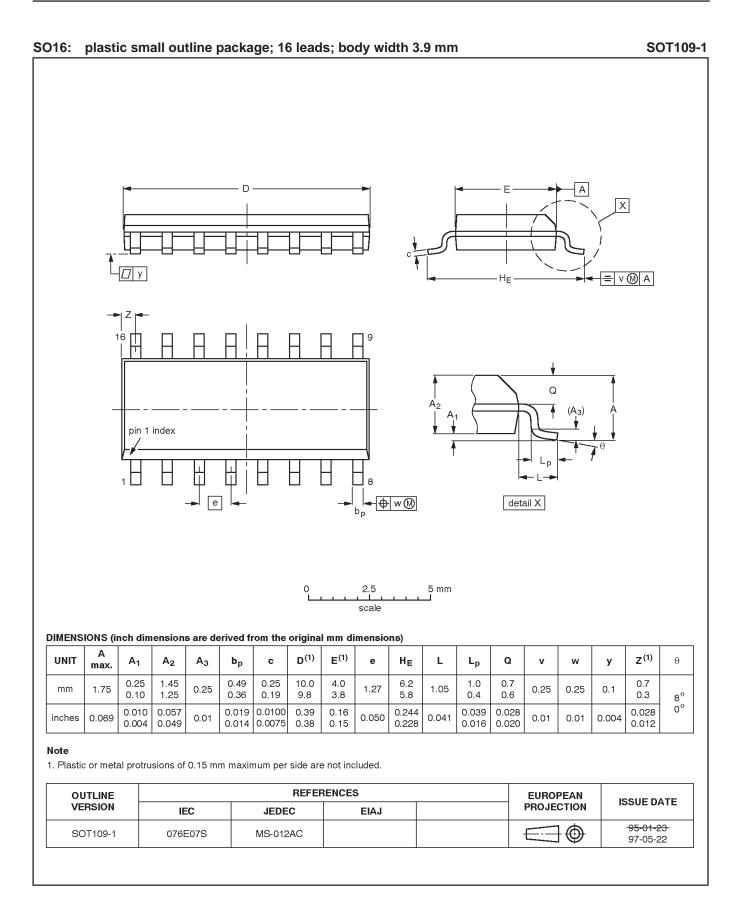


#### Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT38-4						<del>-92-11-17</del> 95-01-14

## 74F257A



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NOTES

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DEFINITIONS					
Data Sheet Identification Product Status Definition		Definition			
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